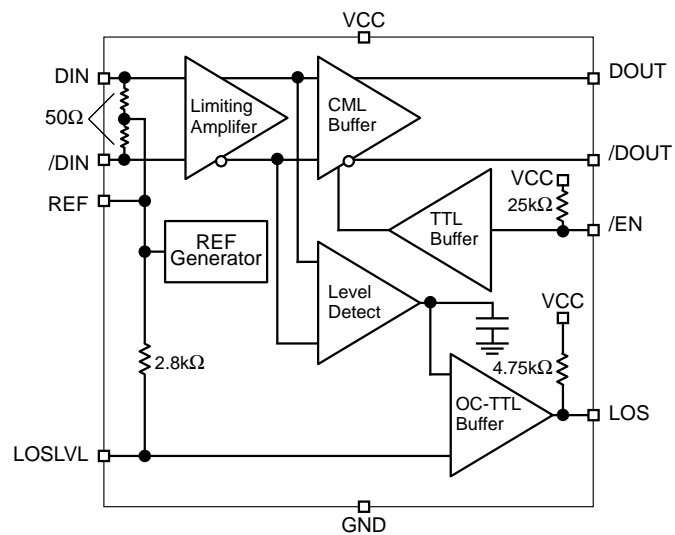
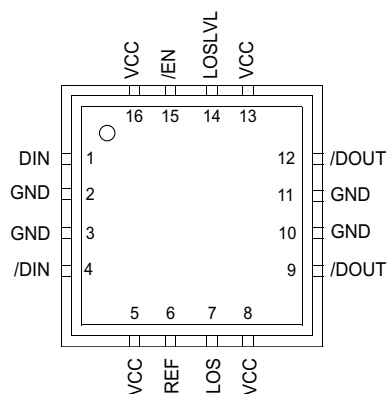
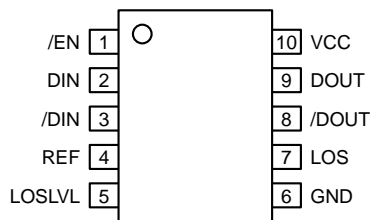


FUNCTIONAL BLOCK DIAGRAM

PACKAGE/ORDERING INFORMATION



16-Pin MLF™ (MLF-16)



10-Pin EPAD-MSOP (K10-2)

Ordering Information⁽¹⁾

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY88973VKI	K10-2	Industrial	973V	Sn-Pb
SY88973VKITR ⁽²⁾	K10-2	Industrial	973V	Sn-Pb
SY88973VMI	MLF-16	Industrial	973V	Sn-Pb
SY88973VMITR ⁽²⁾	MLF-16	Industrial	973V	Sn-Pb
SY88973VEY ⁽³⁾	K10-2	Industrial	973V with Pb-Free bar-line indicator	Pb-Free Matte-Sn
SY88973VEYTR ^(2, 3)	K10-2	Industrial	973V with Pb-Free bar-line indicator	Pb-Free Matte-Sn
SY88973VMG ⁽³⁾	MLF-16	Industrial	973V with Pb-Free bar-line indicator	Pb-Free NiPdAu
SY88973VMGTR ^(2, 3)	MLF-16	Industrial	973V with Pb-Free bar-line indicator	Pb-Free NiPdAu

Notes:

1. Contact factory for die availability. Dice are guaranteed at $T_A = 25^\circ\text{C}$, DC Electricals only.
2. Tape and Reel.
3. Pb-Free package is recommended for new designs.

PIN DESCRIPTION

Pin Number (MSOP)	Pin Number (MLF™)	Pin Name	Type	Pin Function
1	15	/EN	TTL Input: Default is high.	Enable: De-asserts true data output when high. Incorporates 25k Ω pull-up to VCC.
2, 3	1, 4	DIN, /DIN	Differential Data Input	Differential data input. Each pin internally terminates to REF through 50 Ω .
4	6	REF		Reference Voltage: Bypass with 0.01 μF low ESR capacitor from REF to VCC to stabilize LOSLVL and REF.
5	14	LOSLVL	Input: Default is maximum sensitivity.	Loss-of-Signal level set: A resistor from this pin to VCC sets the threshold for the data input amplitude at which the LOS output will be asserted.
6 Exposed Pad	2, 3, 10, 11 Exposed Pad	GND	Ground	Device ground. Exposed pad must be soldered (or equivalent) to the same potential as the ground pins.
7	7	LOS	Open Collector TTL Output with internal 4.75k Ω pull-up resistor	Loss-of-Signal: asserts high when the data input amplitude falls below the threshold set by LOSLVL.
8, 9	9, 12	DOUT, /DOUT	Differential CML Output	Differential data output.
10	5, 8, 13, 16	VCC	Power Supply	Positive power supply. Bypass with 0.1 μF 0.01 μF low ESR capacitors. 0.01 μF capacitors should be as close as possible to VCC pins.

Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V_{CC})	0V to +7.0V
/EN, LOSLVL Voltage	0 to V_{CC}
REF Current	± 1 mA
LOS Current	± 5 mA
DOUT, /DOUT Current	± 25 mA
DIN, /DIN Current	± 10 mA
Storage Temperature (T_S)	-65°C to $+150^\circ\text{C}$
Lead Temperature (Soldering, 20 sec.)	260°C

Operating Ratings⁽²⁾

Supply Voltage (V_{CC})	+3.0V to +3.6V or +4.5V to +5.5V
Ambient Temperature (T_A)	-40°C to $+85^\circ\text{C}$
Junction Temperature (T_J)	-40°C to $+120^\circ\text{C}$
Package Thermal Resistance ⁽³⁾	
MLF TM	
θ_{JA} (Still-Air)	61°C/W
ψ_{JB}	38°C/W
EPAD-MSOP	
θ_{JA} (Still-Air)	38°C/W
ψ_{JB}	22°C/W

DC ELECTRICAL CHARACTERISTICS

$V_{CC} = 3.0\text{V}$ to 3.6V or 4.5V to 5.5V , $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$; typical values at $V_{CC} = 3.3\text{V}$, $T_A = 25^\circ\text{C}$.

Symbol	Parameter	Condition	Min	Typ	Max	Units
I_{CC}	Power Supply Current	3.3V, Note 4 5V, Note 4		28 30	42 45	mA mA
	Power Supply Current	3.3V, Note 5 5V, Note 5		45 47	62 65	mA mA
V_{REF}	REF Voltage			$V_{CC}-1.3$		V
V_{LOSLVL}	LOSLVL Voltage Range		V_{REF}		V_{CC}	V
V_{OH}	Output HIGH Voltage	Note 6	$V_{CC}-0.020$	$V_{CC}-0.005$	V_{CC}	V
V_{OL}	Output LOW Voltage	3.3V, Note 6 5V, Note 6	$V_{CC}-0.475$	$V_{CC}-0.400$	$V_{CC}-0.350$	V
			$V_{CC}-0.510$	$V_{CC}-0.400$	$V_{CC}-0.350$	V
V_{OFFSET}	Differential Output Offset	Note 6			± 80	mV
Z_O	Single-Ended Output Impedance		40	50	60	Ω
Z_I	Single-Ended Input Impedance		40	50	60	Ω

TTL DC ELECTRICAL CHARACTERISTICS

$V_{CC} = 3.0\text{V}$ to 3.6V or 4.5V to 5.5V , $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$.

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{OH}	LOS Output HIGH Level	Sourcing 100 μA	2.4		V_{CC}	V
V_{OL}	LOS Output LOW Level	Sinking 2mA			0.5	V
V_{IH}	/EN Input HIGH Voltage		2.0			V
V_{IL}	/EN Input LOW Voltage				0.8	V
I_{IH}	/EN Input HIGH Current	$V_{IN} = 2.7\text{V}$			20	μA
		$V_{IN} = V_{CC}$			100	μA
I_{IL}	/EN Input LOW Current	$V_{IN} = 0.5\text{V}$	-0.3			mA

Notes:

1. Permanent device damage may occur if Absolute Maximum Ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.
2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
3. Thermal performance assumes the use of 4-layer PCB. Exposed pad must be soldered (or equivalent) to the device's most negative potential on the PCB.
4. Excludes current of CML output stage. See "Detailed Description."
5. Total device current with no output load.
6. Output levels are based on a 50 Ω to V_{CC} load impedance. If the load impedance is different, the output level will be changed. Amplifier is in limiting mode.

AC ELECTRICAL CHARACTERISTICS

$V_{CC} = 3.0V$ to $3.6V$ or $4.5V$ to $5.5V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, $R_{LOAD} = 50\Omega$ to V_{CC} ; typical values at $V_{CC} = 3.3V$, $T_A = 25^{\circ}C$.

Symbol	Parameter	Condition	Min	Typ	Max	Units
PSRR	Power Supply Rejection Ratio			35		dB
t_r, t_f	Output Rise/Fall Time (20% to 80%)	Note 7		60	120	ps
t_{JITTER}	Deterministic Random	Note 8		15 5		ps _{pp} ps _{RMS}
V_{ID}	Differential Input Voltage Swing		10		1800	mV _{pp}
V_{OD}	Differential Output Voltage Swing	3.3V, Note 7 5V, Note 7	700 700	800 800	950 1020	mV _{pp} mV _{pp}
HYS	LOS Hysteresis	Note 9	2	4.6	8	dB
t_{OFF}	LOS Release Time			0.1	0.5	μs
t_{ON}	LOS Assert Time			0.2	0.5	μs
V_{SR}	LOS Sensitivity Range	Note 10	10		35	mV _{pp}
B_{-3dB}	-3dB Bandwidth			2.0		GHz
$A_{V(Diff)}$	Differential Voltage Gain		32	38		dB
S_{21}	Single-Ended Small-Signal Gain		26	32		dB

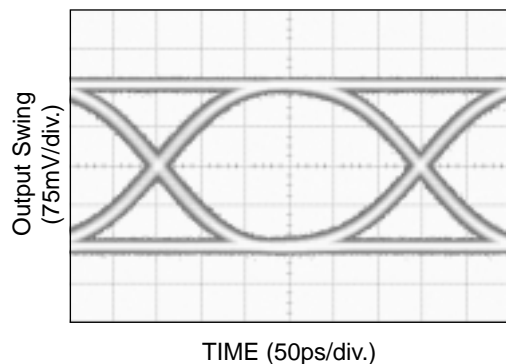
Notes:

7. Amplifier in limiting mode. Input is a 200MHz square wave, $t_r < 300ps$.
8. Deterministic jitter measured using 2.488Gbps K28.5 pattern, $V_{ID} = 10mV_{pp}$. Random jitter measured using 2.488Gbps K28.7 pattern, $V_{ID} = 10mV_{pp}$.
9. Electrical signal.
10. This is the detectable range of input amplitudes that can assert LOS. The input amplitude to deassert LOS is 2–8dB higher than the assert amplitude. See "Typical Operating Characteristics" for graphs showing how to choose a particular V_{LOSLVL} or R_{LOSLVL} for a particular LOS assert, and its associated de-assert, amplitude. If increased LOS sensitivity and hysteresis are required, an application note entitled "Notes on Sensitivity and Hysteresis in Micrel Post Amplifiers" is available at http://www.micrel.com/product-info/app_hints+notes.shtml.

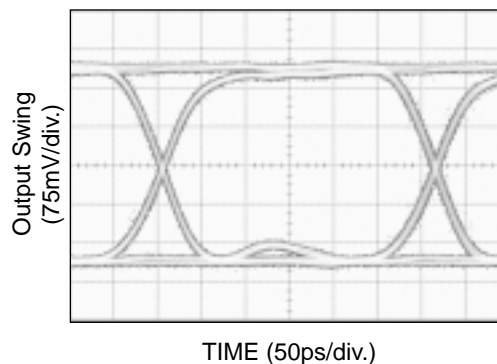
TYPICAL OPERATING CHARACTERISTICS

$V_{CC} = 3.3V$, $T_A = 25^\circ C$, $R_{LOAD} = 50\Omega$ to V_{CC} , unless otherwise stated.

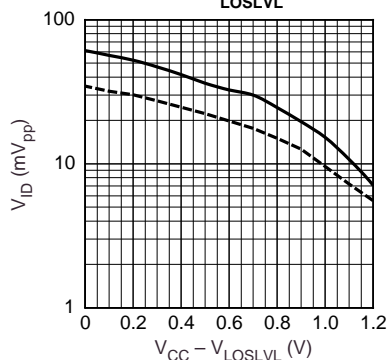
10mV_{pp} Input @3.2Gbps 2³¹-1 PRBS



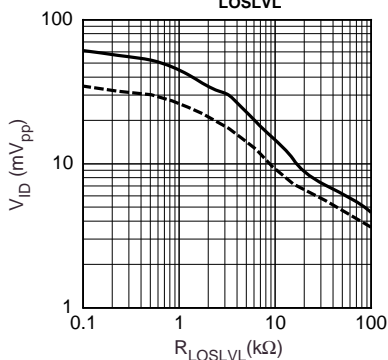
1.8V_{pp} Input @3.2Gbps 2³¹-1 PRBS



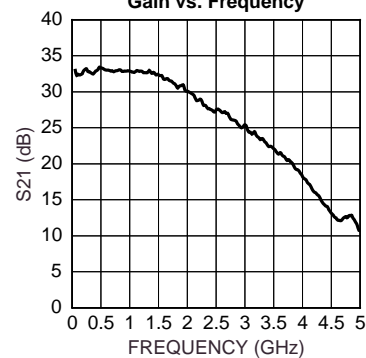
V_{ID} to Assert/De-assert LOS
vs. V_{LOSLVL}



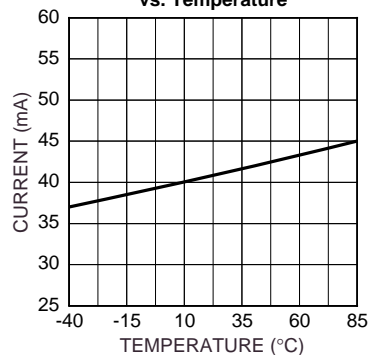
V_{ID} to Assert/De-assert LOS
vs. R_{LOSLVL}



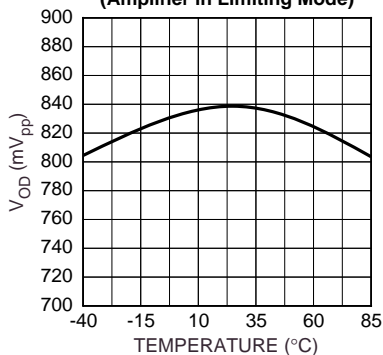
Single-Ended Small-Signal
Gain vs. Frequency



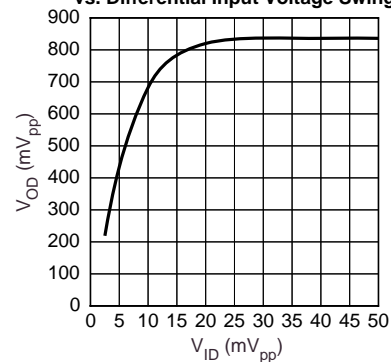
Power Supply Current
vs. Temperature



Differential Output Voltage
Swing vs. Temperature
(Amplifier in Limiting Mode)



Differential Output Voltage Swing
vs. Differential Input Voltage Swing



DETAILED DESCRIPTION

The SY88973V low-power, limiting post amplifier operates from a single $+3.3V \pm 10\%$ or $+5V \pm 10\%$ power supply, over an industrial temperature range of -40°C to $+85^{\circ}\text{C}$. Signals with data rates up to 3.2Gbps and as small as 10mV_{PP} can be amplified. Figure 1 shows the allowed input voltage swing. The SY88973V generates an LOS output, providing feedback to /EN for output stability. LOSLVL sets the sensitivity of the input amplitude detection.

Input Amplifier/Buffer

The SY88973V's inputs are internally terminated with 50Ω to REF. Unless unaffected by this internal termination scheme, upstream devices need to be AC-coupled to the SY88973V's inputs. Figure 2 shows a simplified schematic of the input structure.

The high sensitivity of the input amplifier detects and amplifies signals as small as 10mV_{PP}. The input amplifier allows input signals as large as 1800mV_{PP}. Input signals are linearly amplified with a typical 38dB differential voltage gain. Since it is a limiting amplifier, the SY88973V outputs, typically 800mV_{PP}, voltage-limited waveforms for input signals that are greater than 10mV_{PP}. Applications requiring the SY88973V to operate with high gain should have the upstream TIA placed as close as possible to the SY88973V's input pins to ensure the device's best performance.

Output Buffer

The SY88973V's CML output buffer is designed to drive 50Ω lines. The output buffer requires appropriate termination for proper operation. An external 50Ω resistor to VCC or equivalent for each output pin provides this. Figure 3 shows a simplified schematic of the output structure and includes an appropriate termination method. Of course, driving a downstream device with a CML input that is internally terminated with 50Ω to VCC eliminates the need for external termination. As noted in the previous section, the amplifier outputs, typically 800mV_{PP}, waveforms across 25Ω total loads. The output buffer, thus, switches typically 16mA tail-current. Figure 4 shows the power supply current measurement which excludes the 16mA tail-current.

Loss-of-Signal

The SY88973V incorporates a chatter-free, LOS open-collector TTL output with internal 4.75kΩ pull-up resistor as shown in Figure 5. LOS is used to determine that the input amplitude is too small to be considered a valid input. LOS asserts high if the input amplitude falls below the threshold set by LOSLVL and de-asserts low otherwise. LOS can be fed back to the enable (/EN) input to maintain output stability under a loss of signal condition. /EN de-assert low the true output signal without removing the input signals. Typically 4.6dB LOS hysteresis is provided to prevent chattering.

Loss-of-Signal Level Set

A programmable, loss-of-signal level set pin sets the threshold of the input amplitude detection. Connecting an external resistor between VCC and LOSLVL sets the voltage at LOSLVL. This voltage ranges from V_{CC} to V_{REF}. The external resistor creates a voltage divider between VCC and REF as shown in Figure 6. If desired, an appropriate external voltage may be applied rather than using a resistor. The relationship between V_{LOSLVL} and R_{LOSLVL} is given by:

$$V_{\text{LOSLVL}} = V_{\text{CC}} - 1.3 \frac{R_{\text{LOSLVL}}}{R_{\text{LOSLVL}} + 2.8}$$

where voltages are in volts and resistances are in kΩ.

The smaller the external resistor, which implies a smaller voltage difference from LOSLVL to VCC, the lower the LOS sensitivity. Hence, larger input amplitude is required to deassert LOS. The "Typical Operating Characteristics" section contains graphs showing the relationship between the input amplitude detection sensitivity and V_{LOSLVL} or R_{LOSLVL}.

Hysteresis

The SY88973V provides typically 4.6dB LOS electrical hysteresis. By definition, a power ratio measured in dB is $10\log(\text{power ratio})$. Power is calculated as V_{IN}^2/R for an electrical signal. Hence, the same ratio can be stated as $20\log(\text{voltage ratio})$. While in linear mode, the electrical voltage input changes linearly with the optical power and the ratios change linearly as well. Therefore, the optical hysteresis in dB is half the electrical hysteresis in dB given in the datasheet. The SY88973V provides typically 2.3dB LOS optical hysteresis. As the SY88973V is an electrical device, this datasheet refers to hysteresis in electrical terms. With 4.6dB LOS hysteresis, a voltage factor of 1.7 is required to deassert LOS.

Hysteresis and Sensitivity Improvement

If increased LOS sensitivity and hysteresis are required, an application note entitled "Notes on Sensitivity and Hysteresis in Micrel Post Amplifiers" is available at http://www.micrel.com/product-info/app_hints+notes.shtml.

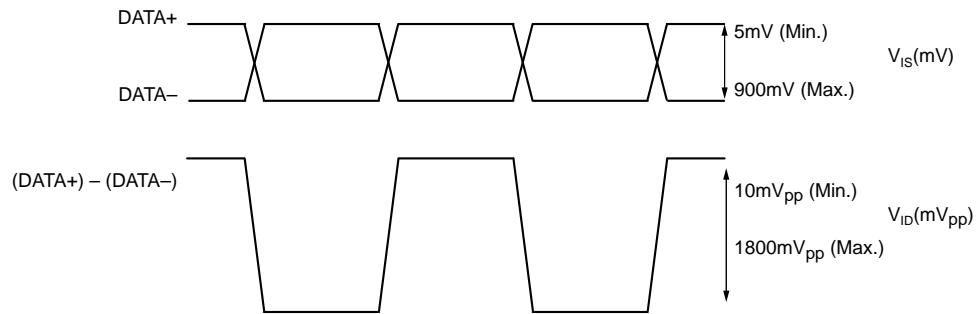
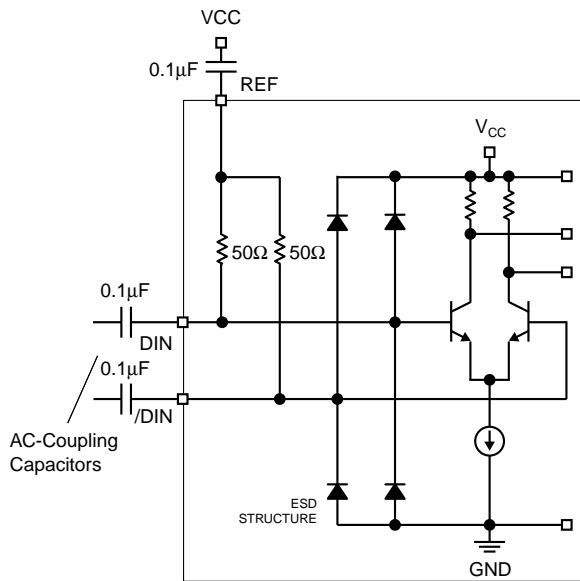
Figure 1. V_{IS} and V_{ID} Definition

Figure 2. Input Structure

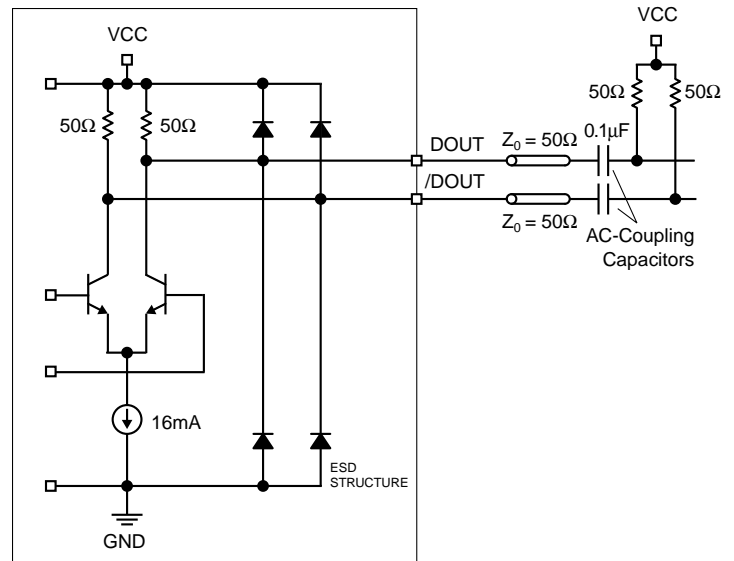


Figure 3. Output Structure

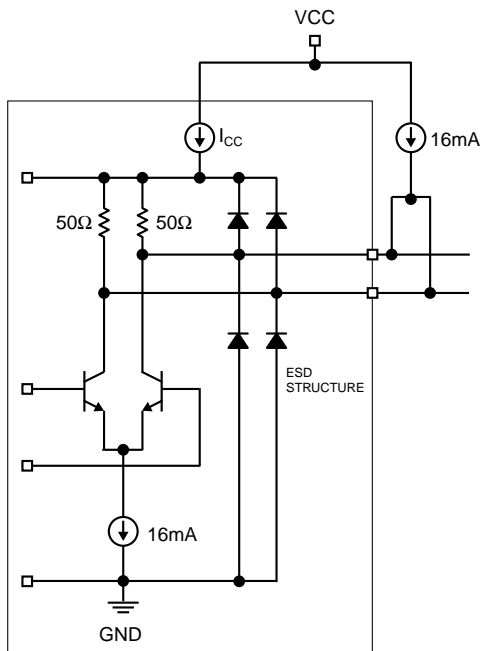


Figure 4. Power Supply Current Measurement

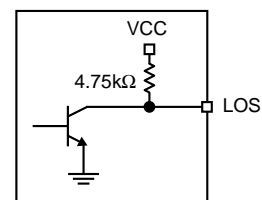


Figure 5. LOS Output Structure

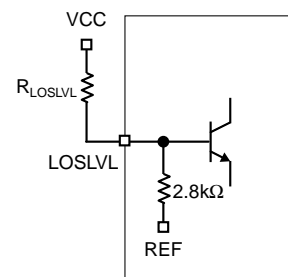
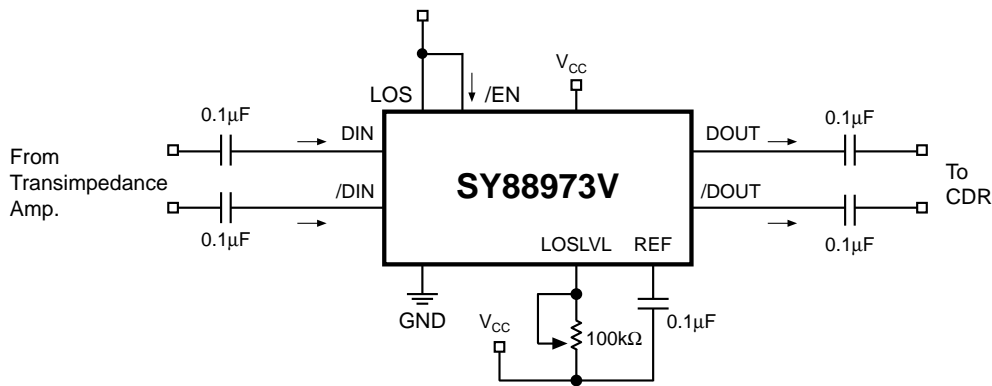


Figure 6. LOSLVL Setting Circuit

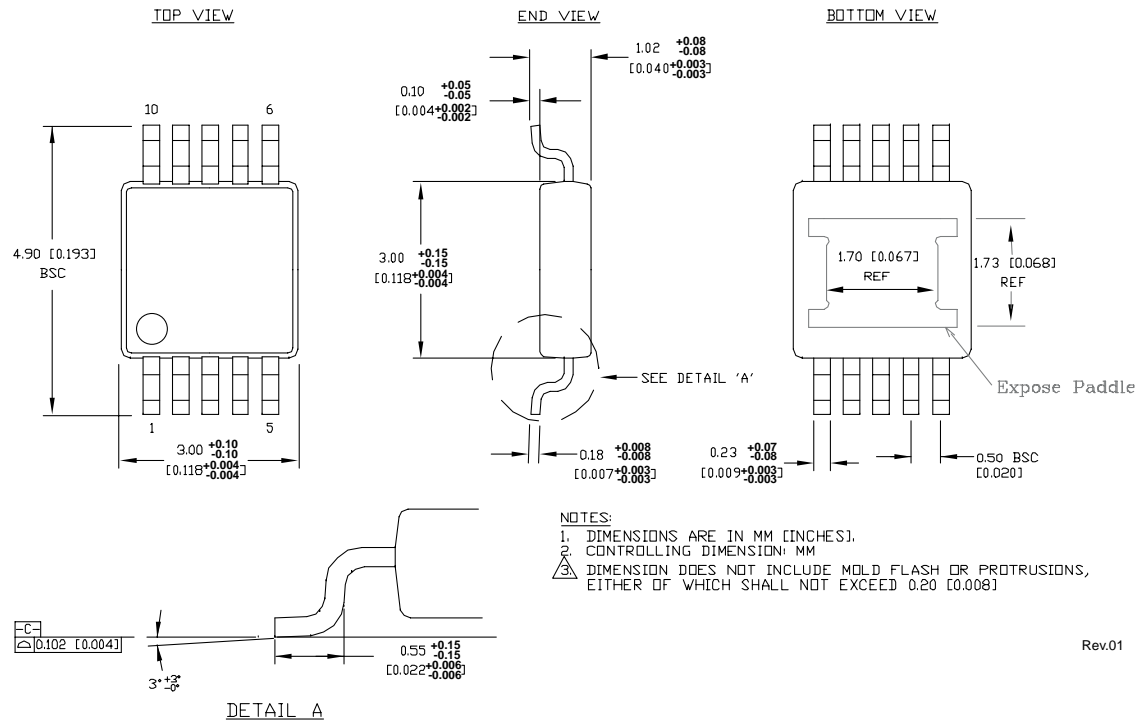
TYPICAL APPLICATIONS CIRCUIT

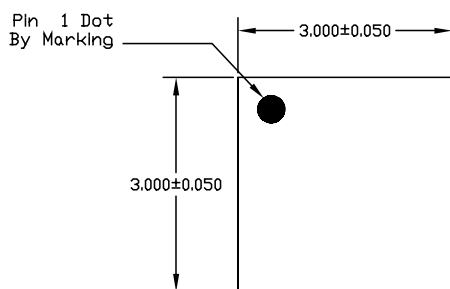


RELATED PRODUCT AND SUPPORT DOCUMENTATION

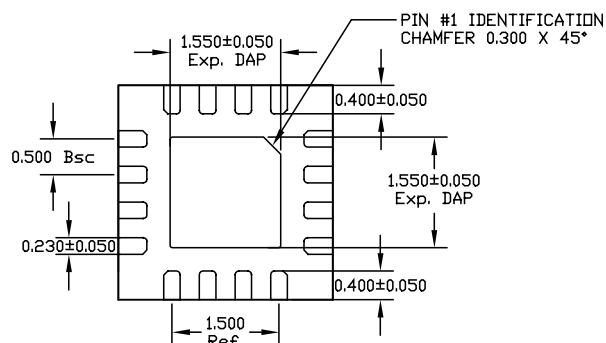
Part Number	Function	Data Sheet Link
SY88773V	3.3V/5V 3.2Gbps CML Low-Power, Limiting Post Amplifier w/ TTL LOS	http://www.micrel.com/_PDF/HBW/sy88773v.pdf
SY88823V	3.3V/5V 3.2Gbps CML Low-Power, Limiting Post Amplifier w/ TTL SD	http://www.micrel.com/_PDF/HBW/sy88823v.pdf
SY88843V	3.3V/5V 3.2Gbps CML Low-Power, Limiting Post Amplifier w/ TTL SD	http://www.micrel.com/_PDF/HBW/sy88843v.pdf
SY88973V	3.3V/5V 3.2Gbps CML Low-Power, Limiting Post Amplifier w/ TTL LOS	http://www.micrel.com/_PDF/HBW/sy88973v.pdf
Application Notes	Notes on Sensitivity and Hysteresis in Micrel Post Amplifiers	http://www.micrel.com/product-info/app_hints+notes.shtml

10 LEAD EPAD-MSOP (K10-2)

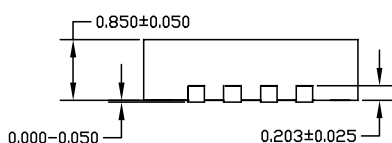


16-PIN *Micro*LEADFRAME™ (MLF-16)

TOP VIEW



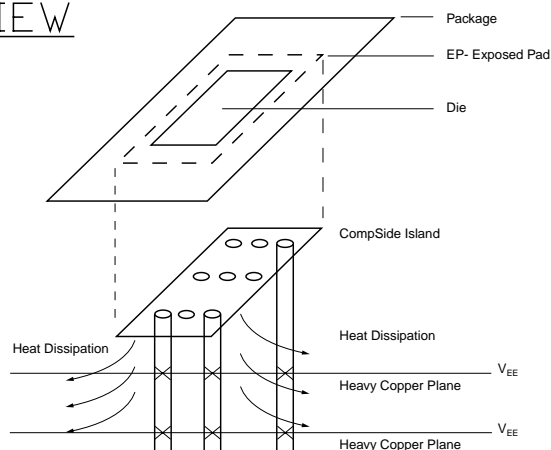
BOTTOM VIEW



SIDE VIEW

NOTE:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. MAX. PACKAGE WARPAGE IS 0.05 mm.
3. MAXIMUM ALLOWABLE BURRS IS 0.076 mm IN ALL DIRECTIONS.
4. PIN #1 ID ON TOP WILL BE LASER/INK MARKED.



PCB Thermal Consideration for 16-Pin MLF™ Package
(Always solder, or equivalent, the exposed pad to the PCB)

Package Notes:

1. Package meets Level 2 qualification.
2. All parts are dry-packaged before shipment.
3. Exposed pads must be soldered to a ground for proper thermal management.

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